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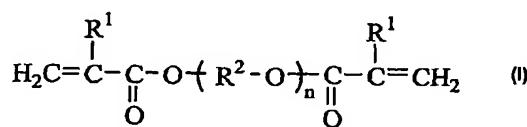
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(54) Title: SILICONE RUBBER COMPOSITION



(57) Abstract: A silicone rubber composition exhibiting superior adhesive properties with respect to organic resins it comes into contact with during its cure, while at the same time possessing superior mold release properties with respect to metal dies used for its molding, contains: (A) a polyorganosiloxane having at least two silicon-bonded alkenyl groups per molecule; (B) a polyorganosiloxane having at least two silicon-bonded hydrogen atoms per molecule; (C) an alkylene glycol ester of diacrylic acid or an alkylene glycol ester of dimethacrylic acid having the formula (I), wherein R1 is hydrogen or a methyl group, R2 represents an alkylene group, and n has a value of 1-10; and (D) a platinum catalyst.

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